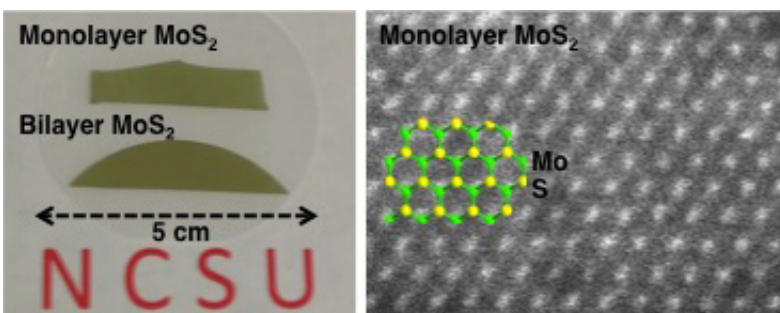


New technique may open up an era of atomic-scale semiconductor devices

May 22 2013, by Matt Shipman



The thin films are only one atom thick, but can be made wide enough to coat wafers that are two inches wide or larger. The films are made of molybdenum sulfide, an inexpensive semiconductor material. Credit: Linyou Cao, North Carolina State University

(Phys.org) —Researchers at North Carolina State University have developed a new technique for creating high-quality semiconductor thin films at the atomic scale – meaning the films are only one atom thick. The technique can be used to create these thin films on a large scale, sufficient to coat wafers that are two inches wide, or larger.

"This could be used to scale current [semiconductor technologies](#) down to the [atomic scale](#) – lasers, light-emitting diodes (LEDs), [computer chips](#), anything," says Dr. Linyou Cao, an assistant professor of [materials science and engineering](#) at NC State and senior author of a paper on the work. "People have been talking about this concept for a long time, but it

wasn't possible. With this discovery, I think it's possible."

The researchers worked with molybdenum sulfide (MoS_2), an inexpensive [semiconductor material](#) with electronic and optical properties similar to materials already used in the [semiconductor industry](#). However, MoS_2 is different from other semiconductor materials because it can be "grown" in layers only one atom thick without compromising its properties.

In the new technique, researchers place sulfur and molybdenum chloride powders in a furnace and gradually raise the temperature to 850 degrees Celsius, which vaporizes the powder. The two substances react at high temperatures to form MoS_2 . While still under [high temperatures](#), the vapor is then deposited in a thin layer onto the substrate.

"The key to our success is the development of a new [growth mechanism](#), a self-limiting growth," Cao says. The researchers can precisely control the thickness of the MoS_2 layer by controlling the partial pressure and vapor pressure in the furnace. Partial pressure is the tendency of atoms or molecules suspended in the air to condense into a solid and settle onto the substrate. Vapor pressure is the tendency of solid atoms or molecules on the substrate to vaporize and rise into the air.

To create a single layer of MoS_2 on the substrate, the partial pressure must be higher than the vapor pressure. The higher the partial pressure, the more layers of MoS_2 will settle to the bottom. If the partial pressure is higher than the vapor pressure of a single layer of atoms on the substrate, but not higher than the vapor pressure of two layers, the balance between the partial pressure and the vapor pressure can ensure that thin-film growth automatically stops once the monolayer is formed. Cao calls this "self-limiting" growth.

Partial pressure is controlled by adjusting the amount of molybdenum

chloride in the furnace – the more molybdenum is in the furnace, the higher the partial pressure.

"Using this technique, we can create wafer-scale MoS₂ monolayer thin films, one atom thick, every time," Cao says. "We can also produce layers that are two, three or four atoms thick."

Cao's team is now trying to find ways to create similar [thin films](#) in which each atomic layer is made of a different material. Cao is also working to create field-effect transistors and LEDs using the technique. Cao has filed a patent on the new technique.

The paper, "Controlled Scalable Synthesis of Uniform, High-Quality Monolayer and Few-layer MoS₂ Films," was published online May 21 in *Scientific Reports*, a journal of the Nature Publishing Group.

More information: "Controlled Scalable Synthesis of Uniform, High-Quality Monolayer and Few-layer MoS₂ Films" Authors: Yifei Yu, Chun Li, Yi Liu, and Linyou Cao, North Carolina State University; Liqin Su and Yong Zhang, University of North Carolina at Charlotte. Published: May 21, *Scientific Reports* www.nature.com/srep/2013/13052.../full/srep01866.html

Provided by North Carolina State University

Citation: New technique may open up an era of atomic-scale semiconductor devices (2013, May 22) retrieved 23 April 2024 from <https://phys.org/news/2013-05-technique-era-atomic-scale-semiconductor-devices.html>

This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.